



NOTE :

1. DIMENSIONS IN MILLIMETERS. ANGLES IN DEGREES.
2. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
3. REFER JEDEC MO-229.
4. RECOMMENDED LAND PATTERN IS FOR REFERENCE ONLY.
5. THERMAL PAD SOLDERING AREA.
6. THE OPTIONAL 4 EXPOSED PADS ARE COINCIDENT WITH THE BOTTOM SIDE OF THE PACKAGE.



DATE: 04/20/11

DESCRIPTION: 10-pin, Very Thin Fine Pitch Dual Flat No Lead (TDFN)

PACKAGE CODE: ZE (ZE10)

DOCUMENT CONTROL #: PD-2092

REVISION: B